MX0160VP LDMOS TRANSISTOR

550W, 50V High Power RF LDMOS FETs

Description

The MX0160VP is a 550-watt capable, high performance, unmatched LDMOS FET, designed for wide-band commercial and industrial applications with frequencies HF to 0.2 GHz.

It is the thermally enhancement of its peer MK0160VP(S)

MX0160VP DRAIN DRAIN GATE GATE SOURCE

Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- · Excellent thermal stability, low HCI drift

- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

Suitable Applications

- 30-88MHz (Ground communication)
- 54-88MHz (TV VHF I)
- 88-108MHz (FM)
- 160-230MHz (TV VHF III)
- 136-174MHz (Commercial ground communication)
- Laser Exciter
- Synchrotron
- MRI
- · Plasma generator
- Weather Radar

Table 1. Maximum Ratings

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Rating	Symbol	Value	Unit
DrainSource Voltage	V _{DSS}	+125	Vdc
GateSource Voltage	V _{GS}	-10 to +10	Vdc
Operating Voltage	V _{DD}	+55	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	T,	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Doug	0.20	0000
T _C = 85°C, T _J =200°C, DC test	Rejc	0.30	°C/W

Table 3. ESD Protection Characteristics

Test Methodology	Class
Human Body Model (per JESD22A114)	Class 2

Table 4. Electrical Characteristics ($T_A = 25$ °C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
DC Characteristics (per half section)					
Drain-Source Voltage	V		125		V
V _{GS} =0, I _{DS} =1.0Ma	$V_{(BR)DSS}$		125		V
Zero Gate Voltage Drain Leakage Current	I _{DSS}			1	
$(V_{DS} = 75V, V_{GS} = 0 V)$				ı	μΑ
Zero Gate Voltage Drain Leakage Current	I _{DSS}			1	μΑ

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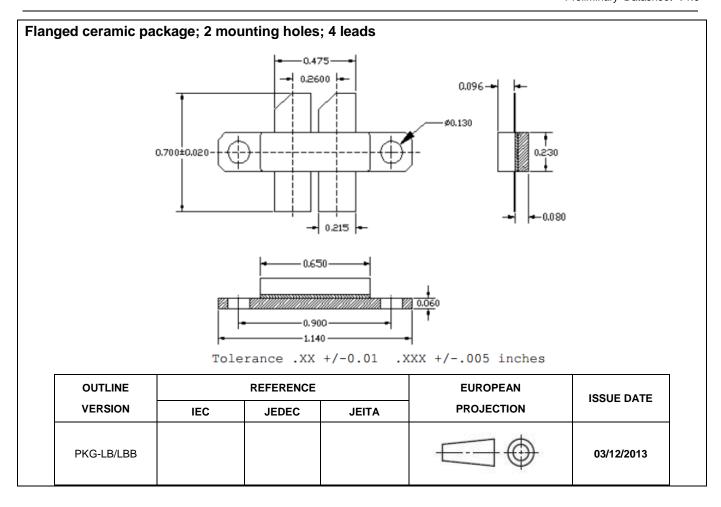
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$(V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V})$					
GateSource Leakage Current				1	μА
$(V_{GS} = 10 \text{ V}, V_{DS} = 0 \text{ V})$	I _{GSS}				
Gate Threshold Voltage	V _{GS} (th)		2.65		V
$(V_{DS} = 50V, I_D = 600 \mu A)$					V
Gate Quiescent Voltage	· · ·		3.25		V
(V _{DD} = 50 V, I _D = 100 mA, Measured in Functional Test)	$V_{GS(Q)}$		3.23		V
Drain source on state resistance	Rds(on)		217		mΩ
(Vds=0.1V, Vgs=10V)	rtus(on)		217		
Common Source Input Capacitance	C _{ISS}		208		pF
$(V_{GS} = 0V, V_{DS} = 50 V, f = 1 MHz)$	CISS		200		ρi
Common Source Output Capacitance	C _{oss}		49.6		pF
$(V_{GS} = 0V, V_{DS} = 50 V, f = 1 MHz)$	Coss		43.0		ρι
Common Source Feedback Capacitance			1.14		nE
$(V_{GS} = 0V, V_{DS} = 50 V, f = 1 MHz)$	C _{RSS}		1.17		pF

Load Mismatch (In Innogration Test Fixture, 50 ohm system): $V_{DD} = 50 \text{ Vdc}$, $I_{DQ} = 100 \text{ mA}$, f = 108MHz, pulse width:100us, duty cycle:10%

Load 20:1 All phase angles, at 500W Pulsed CW Output Power	No Device Degradation
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Revision history

Table 5. Document revision history

Date	Revision	Datasheet Status
2017/9/19	Rev 1.0	Preliminary Datasheet Creation

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